## **BK11 Series**



### **Applications**













**Smartphone** 

**Smart Watches** 

Wireless Earbuds

Introducing Hirose's BK11 Series—an ultra-compact FPC-to-Board connector engineered for power and performance in portable electronics. With a 0.35mm pitch, 0.6mm stacking height, and slim 1.9mm width, the BK11 delivers up to 8A total current through a multi-power hybrid layout featuring 2 main power contacts (4A) and 4 sub power contacts (2.5A).

This structure supports power delivery to multiple modules through a single connector-reducing component count and saving mounting space. Armored metal guides, reinforced solder points, and a tactile click design ensure secure, reliable mating even in compact or vibration-prone devices. Ideal for smartphones, wearables, wireless audio, and other battery-powered products, the BK11 Series offers a robust and space-saving connectivity solution.

#### **KEY BENEFITS OF THE BK11 SERIES INCLUDE:**

 A hybrid design with multi-power and signal contacts—including 2 main power pins (4A) and 4 sub power pins (2.5A)–supporting up to 8A total in one compact connector.

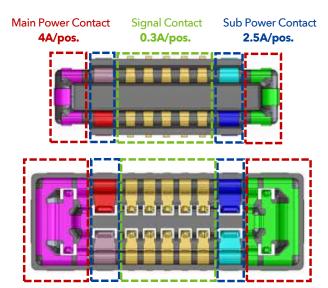
 Optimized to support multiple modules through one connector–reducing signal lines and saving mounting space on the board.

- · A robust structure with fully armored metal guides to prevent housing damage during misalignment.
- Reinforced solder points at each power contact to increase PCB peeling strength and ensure long-term retention.
- Smooth and reliable mating with a wide self-alignment range and a clear tactile click.
- A halogen-free construction that meets IEC 61249-2-21 environmental standards.

### Multi-Power Contact

**Multi-Power Contacts Saves Space** 







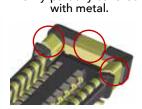


### Robust Design

# **Comparison of Conventional Versus Full Armored Design**

#### **Conventional Products**

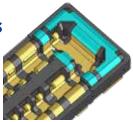
No Metal Covering



Only partially covered

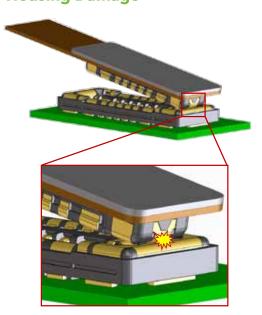
Exposed Housing

**BK11 Series** 



Housing is covered by metal

# **Fully Armored Design Prevents Housing Damage**



## **Specifications**

#### Material/Finish

Component	Material	Finish, Remarks
Housing	LCP*	Black, UL94V -0
Signal Contact	Copper alloy	Gold plated (Nickel Underplated)
Power Contact	Copper alloy	Gold plated (Nickel Underplated)

<sup>\*1</sup> This product satisfies halogen free requirements defined as 900ppm maximum chlorine, 900ppm maximum bromine, and 1500ppm maximum total of chlorine and bromine.

#### Performance Characteristics

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Rated Current	Main Power Contact: 4A/pos. Sub Power Contact: 2.5A/pos. Signal Contact: 0.3A/pos.	
Rated Voltage	30V AC/DC	
Operating Temperature	-55 to +85° C*2	
Contact Resistance	Power Contact : $30 \text{m}\Omega$ Max. Signal Contact: $50 \text{m}\Omega$ Max.	
Withstanding Voltage	100V AC for 1 min.	
Insulation Resistance	50MΩ Min. (100V DC)	
Mating Durability	10 times	

- No. of Pos.: Signal 10pos.+Power 6pos.



For additional information please go to www.hirose.com/product/series/BK11

Specifications herein are subject to change without notice. Contact Hirose for latest specifications, drawings, or availabilities.













 $<sup>^{\</sup>star 2}$  Includes the temperature rise due to current flow.